



Selected papers from the ICNN 2019 and ICAFM 2019

Guest Editor:

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Message from the Guest Editor

Dear Colleagues,

This Special Issue will publish selected papers from the 8th International Conference on Nanostructures, Nanomaterials and Nanoengineering 2019 (ICNN 2019, Kyoto, Japan, 11–14 October 2019, <http://icnnn.org>) and the 4th International Conference on Advanced Functional Materials (ICAFM 2019, Salt Lake City, UT, USA, 2–5 August, 2019, <http://icafm.org/>). We aim to collect expanded and high-quality conference papers from ICNN 2019 and ICAFM 2019.

Potential topics include, but are not limited to:

- Different methods for the growth of nanostructures
- Characterization of nanomaterials
- Organic, inorganic, and biomedical applications of nanomaterials and devices
- Different kinds and morphologies of nanostructures: metals and metal oxides of nanoparticle, nanowires and nanorod, carbon nanotube, and graphene
- Nanostructured thin films and coatings
- Nanocomposites
- Semiconductor and functional nanomaterials and devices
- Nanostructured ceramic
- Mechanical, thermal, electric, optical, and magnetic properties of nanomaterials
- Modification of nanomaterials
- Nanoengineering





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Editor-in-Chief

Message from the Editor-in-Chief

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